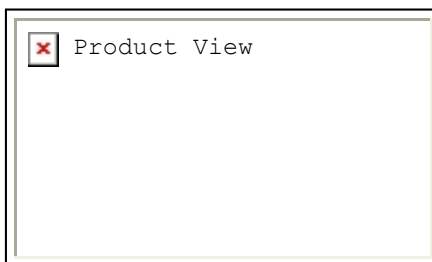


## 390195-6 Product Details

 [Live Product Chat](#)
**390195-6**

TE Internal Number: 390195-6

 **Obsolete**
[Contact Product Information Center](#)
[View 3D PDF](#)

### Memory Sockets

[Not EU RoHS or ELV Compliant \(Find RoHS Compliant Alternates\)](#)

#### Product Highlights:

- DIMM 2P
- Gold Flash over Palladium Nickel or Gold (30) over Nickel Contact Mating Area Plating Material
- Number of Positions = 168
- DRAM Type = Non-Buffered
- DRAM Voltage = 3.3 V

[View all Features](#)

### Quick Links

- [Check Pricing & Availability](#)
- [Search for Tooling](#)
- [Product Feature Selector](#)
- [Contact Us About This Product](#)

[Add to My Part List](#)  [Request Sample](#)  [Find Similar Products](#)  [Buy Product](#) 

### Documentation & Additional Information

#### Product Drawings:

- None Available

#### Catalog Pages/Data Sheets:

- None Available

#### Product Specifications:

- None Available

#### Application Specifications:

- None Available

#### Instruction Sheets:

- None Available

#### CAD Files: ([CAD Format & Compression Information](#))

- [2D Drawing](#) (DXF, Version D)
- [3D Model](#) (IGES, Version D)
- [3D Model](#) (STEP, Version D)

#### Additional Information:

- [Product Line Information](#)

#### Related Products:

- [Tooling](#)

[List all Documents](#)

### Product Features (Please use the Product Drawing for all design activity)

#### Product Type Features:

- Product Type = DIMM 2P
- [Number of Positions](#) = 168
- [DRAM Type](#) = Non-Buffered
- PCB Mount Style = Through Hole
- [Module Orientation](#) = 25°
- PCB Retention Feature = Yes
- Profile = Low

#### Mechanical Attachment:

- [Center Retention Hole Diameter \(mm \[in\]\)](#) = 2.40 [0.094]

#### Electrical Characteristics:

- [DRAM Voltage](#) = 3.3 V

#### Termination Related Features:

- [Termination Post Length \(mm \[in\]\)](#) = 2.60 [0.102]
- Solder Tail Contact Plating = Tin-Lead over Nickel

#### Body Related Features:

- [Row-to-Row Spacing \(mm \[in\]\)](#) = 1.60 [0.063]
- [Centerline \(mm \[in\]\)](#) = 1.27 [0.050]
- [Number of Rows](#) = Dual
- Ejector Type = Standard
- [Ejector Location](#) = Both Ends
- Center Post = With
- [Number of Keys](#) = 2
- PCB Retention Method = Boardlock(s)
- Mount Type = Printed Circuit Board
- Module Key Type = Key1= Offset Right / Key2= Center

#### Contact Related Features:

- Contact Mating Area Plating Material = Gold Flash over Palladium Nickel or Gold (30) over Nickel
- Contact Base Material = Phosphor Bronze
- [Retention Post\(s\) Location](#) = Center

#### Housing Related Features:

- Housing Material = High Temperature Thermoplastic
- Housing Color = Black
- Housing Flammability Rating = UL 94V-0

#### Configuration Related Features:

- [Insertion Style](#) = Direct Insert
- Center Key (mm [in]) = Center

#### Industry Standards:

- [RoHS/ELV Compliance](#) = Not ELV/RoHS compliant
- [Lead Free Solder Processes](#) = Wave solder capable to 240°C

#### Packaging Related Features:

- Packaging Method = Tray

#### Other:

- Brand = AMP

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